onsemi

Small Signal Diodes MMBD1401, MMBD1403, MMBD1404, MMBD1405

ABSOLUTE MAXIMUM RATINGS

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ (Notes 1, 2)

Rating	Symbol	Value	Unit
Maximum Repetitive Reverse Voltage	V _{RRM}	200	V
Average Rectified Forward Current	I _{F(AV)}	200	mA
Non-Repetitive Peak Forward Surge Current Pulse Width = 1.0 second Pulse Width = 1.0 microsecond	I _{FSM}	1.0 2.0	A
Storage Temperature Range	T _{STG}	–55 to +150	°C
Operating Junction Temperature	TJ	150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. These ratings are based on a maximum junction temperature of 150°C.

2. These are steady-state limits. **onsemi** should be consulted on applications involving pulsed or low-duty-cycle operations.

THERMAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Value	Unit
Power Dissipation	PD	350	mW
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	357	°C/W

ELECTRICAL CHARACTERISTICS

$(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Parameter	Symbol	Condition	Min	Max	Unit
Breakdown Voltage	B _V	I _R = 100 μA	200	-	V
Forward Voltage	V _F	I _F = 10 mA	-	800	mV
		I _F = 50 mA	760	920	mV
		I _F = 200 mA	-	1.0	V
		I _F = 300 mA	-	1.1	V
Reverse Current	I _R	V _R = 120 V	-	40	nA
		V _R = 175 V	-	100	nA
Total Capacitance	C _T	V _R = 0, f = 1.0 MHz	-	2.0	pF
Reverse Recovery Time	t _{rr}	$\begin{array}{l} I_F = I_R = 30 \text{ mA}, \\ I_{RR} = 3.0 \text{ mA}, \\ R_L = 100 \ \Omega \end{array}$	-	50	ns

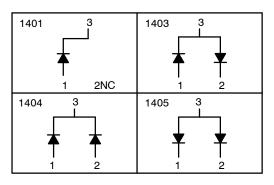
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.





SOT-23 CASE 318BM SOT-23 CASE 318-08

CONNECTION DIAGRAMS



MARKING DIAGRAM



XX = Specific Device Code

XX = 29/32/33/34 M = Date Code

= Pb–Free Package

(Note: Microdot may be in either location)

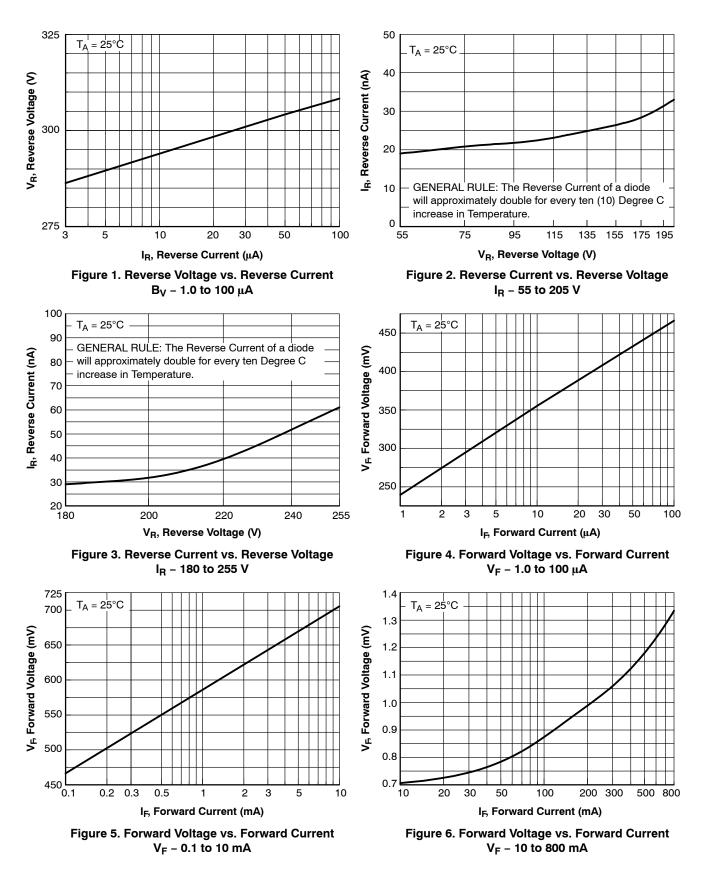
ORDERING INFORMATION

Device	Package	Shipping [†]
MMBD1401	SOT-23 (Pb-Free)	3000 / Tape & Reel
MMBD1403	SOT-23 (Pb-Free)	3000 / Tape & Reel
MMBD1404	SOT-23 (Pb-Free)	3000 / Tape & Reel
MMBD1405	SOT-23 (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

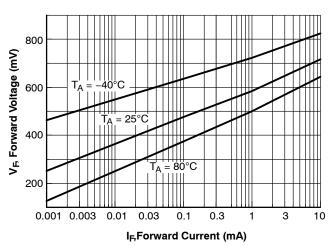
MMBD1401, MMBD1403, MMBD1404, MMBD1405

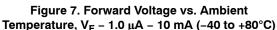
TYPICAL CHARACTERISTICS



MMBD1401, MMBD1403, MMBD1404, MMBD1405

TYPICAL CHARACTERISTICS (Continued)





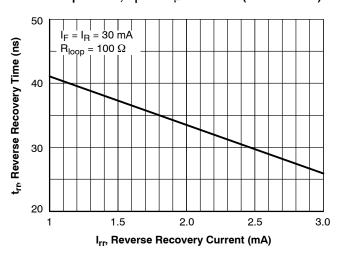


Figure 9. Reverse Recovery Time vs. Reverse Recovery Current (I_{rr})

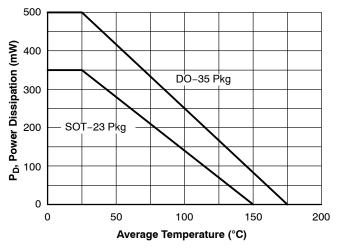


Figure 11. Power Derating Curve

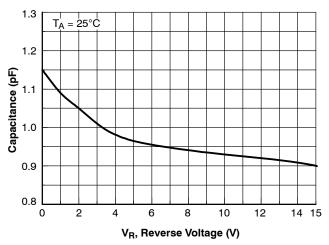


Figure 8. Capacitance vs. Reverse Voltage

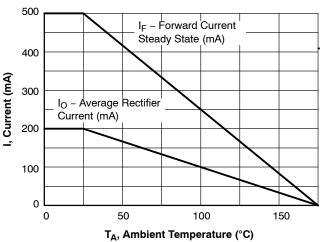


Figure 10. Average Rectified Current (I_0) and Forward Current (I_F) vs. Ambient Temperature (T_A)





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SOT-23 CASE 318BM **ISSUE A** DATE 01 SEP 2021 NOTES: UNLESS OTHERWISE SPECIFIED А D A) REFERENCE JEDEC REGISTRATION 3 TO-236, VARIATION AB, ISSUE H. В B) ALL DIMENSIONS ARE IN MILLIMETERS. C) DIMENSIONS ARE INCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR EXTRUSIONS. D) DIMENSIONING AND TOLERANCING PER E1 ASME Y14.5M - 2009. MILLIMETERS DIM SEE DETAIL A NOM. MIN. MAX. А 1.20 2 A1 0.00 0.05 0.10 (z) A2 0.93 REF b b 0.37 0 44 0.60 е ⊕ 0.20(M) A B 0.08 0.23 с 0.15 e1 D 2.72 2.92 3.12 F Е 2.10 2.40 2.70 E1 1.15 1.30 1.50 0.95 е 0.95 BSC (A2) A1 1.90 BSC e1 0.20 L --------0.10M C \square 1.40 L1 0.55 REF С z 0.29 REF GAGE PLANE 2.20 0.25 С 1 SEATING - 1.00 PLANE - (L1) -1.90 DETAIL A LAND PATTERN SCALE: 2X RECOMMENDATION *FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATEGY AND SOLDERING GENERIC DETAILS, PLEASE DOWNLOAD THE ON **MARKING DIAGRAM*** SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D. XXXM-. *This information is generic. Please refer to device data sheet for actual part marking. XXX = Specific Device Code Pb-Free indicator, "G" or microdot "•", may Μ = Date Code or may not be present. Some products may = Pb-Free Package not follow the Generic Marking. Electronic versions are uncontrolled except when accessed directly from the Document Repository. **DOCUMENT NUMBER:** 98AON13784G Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. **DESCRIPTION:** SOT-23 PAGE 1 OF 1

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